

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

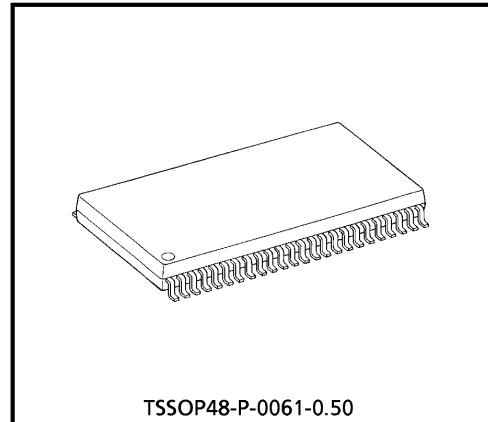
TC74VCX16374FT**LOW-VOLTAGE 16-BIT D-TYPE FLIP-FLOP
WITH 3.6 V TOLERANT INPUTS AND OUTPUTS**

The TC74VCX16374FT is a high performance CMOS 16-bit D-TYPE FLIP FLOP. Designed for use in 1.8, 2.5 or 3.3 Volt systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

It is also designed with over voltage tolerant inputs and outputs up to 3.6 V.

This 16-bit D-type flip-flop is controlled by a clock input (CK) and a output enable input (\overline{OE}) which are common to each byte. It can be used as two 8-bit flip-flops or one 16-bit flip-flop. When the \overline{OE} input is high, the outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge.



Weight : 0.25 g (Typ.)

FEATURES

- Low Voltage Operation : $V_{CC} = 1.8\sim 3.6$ V
- High Speed Operation : $t_{pd} = 3.0$ ns (max) at $V_{CC} = 3.0\sim 3.6$ V
 $t_{pd} = 3.9$ ns (max) at $V_{CC} = 2.3\sim 2.7$ V
 $t_{pd} = 6.0$ ns (max) at $V_{CC} = 1.8$ V
- 3.6 V Tolerant inputs and outputs.
- Output Current : $I_{OH}/I_{OL} = \pm 24$ mA (min) at $V_{CC} = 3.0$ V
 $I_{OH}/I_{OL} = \pm 18$ mA (min) at $V_{CC} = 2.3$ V
 $I_{OH}/I_{OL} = \pm 6$ mA (min) at $V_{CC} = 1.8$ V
- Latch-up Performance : ± 300 mA
- ESD Performance : Human Body Model $> \pm 2000$ V
Machine Model $> \pm 200$ V
- Package : TSSOP
(Thin Shrink Small Outline Package)
- Power Down Protection is provided on all inputs and outputs.
- Supports live insertion / withdrawal (Note 1)

(Note 1) : To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

PIN CONNECTION

\overline{OE}	1	O	48	1CK
1Q1	2		47	1D1
1Q2	3		46	1D2
GND	4		45	GND
1Q3	5		44	1D3
1Q4	6		43	1D4
V_{CC}	7		42	V_{CC}
1Q5	8		41	1D5
IQ6	9		40	1D6
GND	10		39	GND
1Q7	11		38	1D7
1Q8	12		37	1D8
2Q1	13		36	2D1
2Q2	14		35	2D2
GND	15		34	GND
2Q3	16		33	2D3
2Q4	17		32	2D4
V_{CC}	18		31	V_{CC}
2Q5	19		30	2D5
2Q6	20		29	2D6
GND	21		28	GND
2Q7	22		27	2D7
2Q8	23		26	2D8
\overline{OE}	24		25	2CK

(TOP VIEW)

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TRUTH TABLE

INPUT			OUTPUT
$1\overline{OE}$	$1CK$	$1D1-1D8$	$1Q1-1Q8$
H	X	X	Z
L	—	X	Q_n
L	—	L	L
L	—	H	H

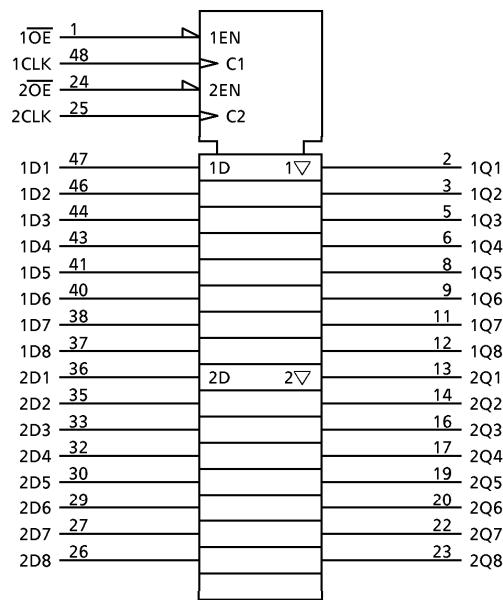
INPUT			OUTPUT
$2\overline{OE}$	$2CK$	$2D1-2D8$	$2Q1-2Q8$
H	X	X	Z
L	—	X	Q_n
L	—	L	L
L	—	H	H

X : Don't Care

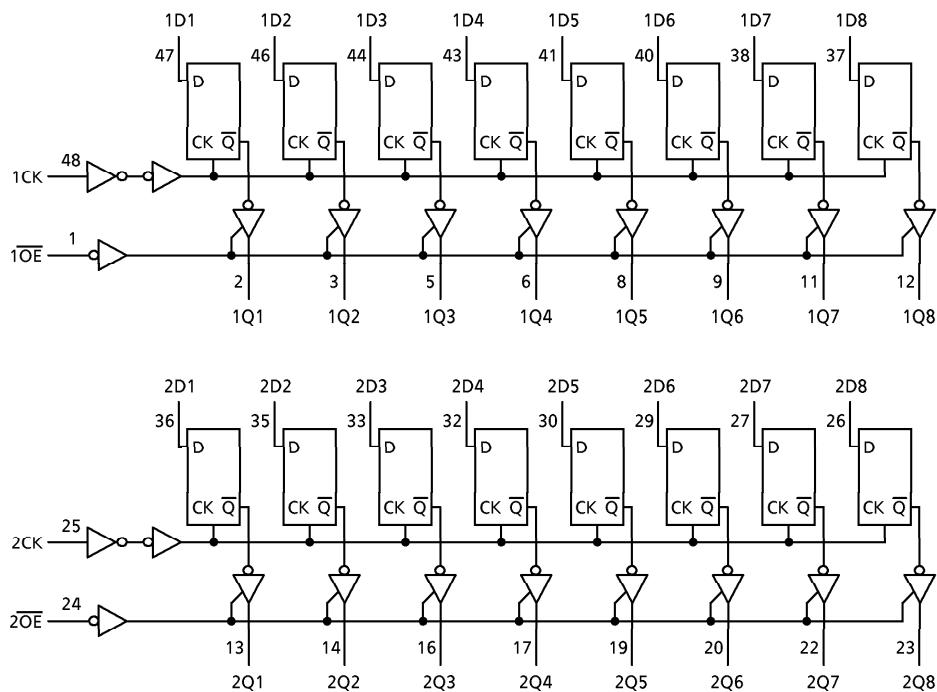
Z : High impedance

 Q_n : No change

IEC LOGIC SYMBOL



SYSTEM DIAGRAM



MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT
Power Supply Voltage	V_{CC}	-0.5~4.6	V
DC Input Voltage	V_{IN}	-0.5~4.6	V
DC Output Voltage	V_{OUT}	-0.5~4.6 (Note 1)	V
		-0.5~ V_{CC} + 0.5 (Note 2)	
Input Diode Current	I_{IK}	-50	mA
Output Diode Current	I_{OK}	± 50 (Note 3)	mA
DC Output Current	I_{OUT}	± 50	mA
Power Dissipation	P_D	400	mW
DC V_{CC} / Ground Current Per Supply Pin	I_{CC}/I_{GND}	± 100	mA
Storage Temperature	T_{stg}	-65~150	°C

(Note 1) : Off-State

(Note 2) : High or Low State. I_{OUT} absolute maximum rating must be observed.(Note 3) : $V_{OUT} < GND$, $V_{OUT} > V_{CC}$ **RECOMMENDED OPERATING RANGE**

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V_{CC}	1.8~3.6	V
		1.2~3.6 (Note 4)	
Input Voltage	V_{IN}	-0.3~3.6	V
Output Voltage	V_{OUT}	0~3.6 (Note 5)	V
		0~ V_{CC} (Note 6)	
Output Current	I_{OH}/I_{OL}	± 24 (Note 7)	mA
		± 18 (Note 8)	
		± 6 (Note 9)	
Operating Temperature	T_{opr}	-40~85	°C
Input Rise And Fall Time	dt/dv	0~10 (Note 10)	ns/V

(Note 4) : Data Retention Only

(Note 5) : Off-State

(Note 6) : High or Low State

(Note 7) : $V_{CC} = 3.0\sim 3.6$ V(Note 8) : $V_{CC} = 2.3\sim 2.7$ V(Note 9) : $V_{CC} = 1.8$ V(Note 10) : $V_{IN} = 0.8\sim 2.0$ V, $V_{CC} = 3.0$ V

ELECTRICAL CHARACTERISTICS

DC characteristics ($T_a = -40\text{~}85^\circ\text{C}$, $2.7\text{ V} < V_{CC} \leq 3.6\text{ V}$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN	MAX	UNIT	
Input Voltage	"H" Level								
	"L" Level	V_{IL}			2.7~3.6	—	0.8		
Output Voltage	"H" Level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100\text{ }\mu\text{A}$	2.7~3.6	$V_{CC} - 0.2$	—	V	
				$I_{OH} = -12\text{ mA}$	2.7	2.2	—		
				$I_{OH} = -18\text{ mA}$	3.0	2.4	—		
				$I_{OH} = -24\text{ mA}$	3.0	2.2	—		
	"L" Level	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100\text{ }\mu\text{A}$	2.7~3.6	—	0.2	V	
				$I_{OL} = 12\text{ mA}$	2.7	—	0.4		
				$I_{OL} = 18\text{ mA}$	3.0	—	0.4		
				$I_{OL} = 24\text{ mA}$	3.0	—	0.55		
Input Leakage Current		I_{IN}	$V_{IN} = 0\text{~}3.6\text{ V}$		2.7~3.6	—	± 5.0	μA	
3-State Output Off-State Current		I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0\text{~}3.6\text{ V}$		2.7~3.6	—	± 10.0	μA	
Power Off Leakage Current		I_{OFF}	$V_{IN}, V_{OUT} = 0\text{~}3.6\text{ V}$		0	—	10.0	μA	
Quiescent Supply Current		I_{CC}	$V_{IN} = V_{CC}$ or GND	2.7~3.6		—	20.0	μA	
			$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6\text{ V}$	2.7~3.6		—	± 20.0		
Increase In I_{CC} Per Input		ΔI_{CC}	$V_{IH} = V_{CC} - 0.6\text{ V}$		2.7~3.6	—	750	μA	

ELECTRICAL CHARACTERISTICSDC characteristics ($T_a = -40\sim85^\circ C$, $2.3 V \leq V_{CC} \leq 2.7 V$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN	MAX	UNIT	
Input Voltage	"H" Level	V_{IH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100 \mu A$	2.3~2.7	1.6	—	V	
	"L" Level	V_{IL}		$I_{OH} = -6 mA$	2.3~2.7	—	0.7		
Output Voltage	"H" Level	V_{OH}		$I_{OH} = -12 mA$	2.3	2.0	—	V	
				$I_{OH} = -18 mA$	2.3	1.8	—		
				$I_{OL} = 100 \mu A$	2.3~2.7	—	0.2		
				$I_{OL} = 12 mA$	2.3	—	0.4		
	"L" Level	V_{OL}		$I_{OL} = 18 mA$	2.3	—	0.6		
				$V_{IN} = 0\sim3.6 V$	2.3~2.7	—	± 5.0	μA	
				$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0\sim3.6 V$	2.3~2.7	—	± 10.0	μA	
				$V_{IN}, V_{OUT} = 0\sim3.6 V$	0	—	10.0	μA	
Quiescent Supply Current		I_{CC}	$V_{IN} = V_{CC}$ or GND	2.3~2.7	—	20.0	μA		
			$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 V$	2.3~2.7	—	± 20.0			

ELECTRICAL CHARACTERISTICSDC characteristics ($T_a = -40\sim85^\circ C$, $1.8 V \leq V_{CC} < 2.3 V$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN	MAX	UNIT	
Input Voltage	"H" Level	V_{IH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100 \mu A$	1.8~2.3	$0.7 \times V_{CC}$	—	V	
	"L" Level	V_{IL}		$I_{OH} = -6 mA$	1.8~2.3	—	$0.2 \times V_{CC}$		
Output Voltage	"H" Level	V_{OH}		$I_{OH} = -12 mA$	1.8	$V_{CC} - 0.2$	—	V	
				$I_{OH} = -18 mA$	1.8	1.4	—		
				$I_{OL} = 100 \mu A$	1.8	—	0.2		
				$I_{OL} = 6 mA$	1.8	—	0.3		
	"L" Level	V_{OL}		$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0\sim3.6 V$	1.8	—	± 10.0	μA	
				$V_{IN}, V_{OUT} = 0\sim3.6 V$	0	—	10.0	μA	
				$V_{IN} = V_{CC}$ or GND	1.8	—	20.0	μA	
				$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 V$	1.8	—	± 20.0		

AC characteristics ($T_a = -40\sim85^\circ C$, Input $t_r = t_f = 2.0 \text{ ns}$, $C_L = 30 \text{ pF}$, $R_L = 500 \Omega$)

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC} (\text{V})$	MIN	MAX	UNIT
			1.8	125	—	
Maximum Clock Frequency	f_{MAX}	(Fig.1, 2)	2.5 ± 0.2	200	—	MHz
			3.3 ± 0.3	250	—	
			1.8	1.5	6.0	
Propagation Delay Time (CK-Q)	t_{pLH} t_{pHL}	(Fig.1, 2)	2.5 ± 0.2	1.0	3.9	ns
			3.3 ± 0.3	0.8	3.0	
			1.8	1.5	7.0	
3-State Output Enable Time	t_{pZL} t_{pZH}	(Fig.1, 3)	2.5 ± 0.2	1.0	4.6	ns
			3.3 ± 0.3	0.8	3.5	
			1.8	1.5	5.0	
3-State Output Disable Time	t_{pLZ} t_{pHZ}	(Fig.1, 3)	2.5 ± 0.2	1.0	3.8	ns
			3.3 ± 0.3	0.8	3.5	
			1.8	3.0	—	
Minimum Pulse Width (CK)	$t_w (\text{H})$ $t_w (\text{L})$	(Fig.1, 2)	2.5 ± 0.2	1.5	—	ns
			3.3 ± 0.3	1.5	—	
			1.8	2.5	—	
Minimum Set-up Time	t_s	(Fig.1, 2)	2.5 ± 0.2	1.5	—	ns
			3.3 ± 0.3	1.5	—	
			1.8	1.0	—	
Minimum Hold Time	t_h	(Fig.1, 2)	2.5 ± 0.2	1.0	—	ns
			3.3 ± 0.3	1.0	—	
			1.8	—	0.5	
Output To Output Skew	t_{osLH} t_{osHL}	(Note 11)	2.5 ± 0.2	—	0.5	ns
			3.3 ± 0.3	—	0.5	

For $C_L = 50 \text{ pF}$, add approximately 300 ps to the AC maximum specification.

(Note 11) : Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

Dynamic switching characteristics ($T_a = 25^\circ\text{C}$, Input $t_r = t_f = 2.0 \text{ ns}$, $C_L = 30 \text{ pF}$)

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC} (\text{V})$	TYP.	UNIT
Quiet Output Maximum Dynamic V_{OL}	V_{OLP}	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	1.8	0.25	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	2.5	0.6	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	3.3	0.8	
Quiet Output Minimum Dynamic V_{OL}	V_{OLV}	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	1.8	-0.25	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	2.5	-0.6	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	3.3	-0.8	
Quiet Output Minimum Dynamic V_{OH}	V_{OHV}	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	1.8	1.5	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	2.5	1.9	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	3.3	2.2	

(Note 12) : Parameter guaranteed by design.

Capacitive characteristics ($T_a = 25^\circ\text{C}$)

PARAMETER	SYMBOL	TEST CONDITION	$V_{CC} (\text{V})$	TYP.	UNIT
Input Capacitance	C_{IN}		1.8, 2.5, 3.3	6	pF
Output Capacitance	C_O		1.8, 2.5, 3.3	7	pF
Power Dissipation Capacitance	C_{PD}	$f_{IN} = 10 \text{ MHz}$ (Note 13)	1.8, 2.5, 3.3	20	pF

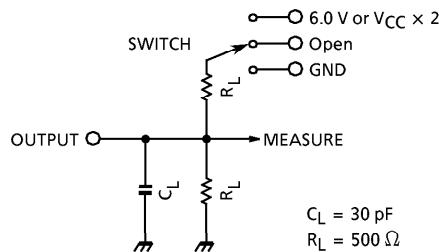
(Note 13) : C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC(\text{opr.})} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 16 \text{ (per bit)}$$

TEST CIRCUIT

Fig.1



PARAMETER	SWITCH
t_{pLH}, t_{pHL}	Open
t_{pLZ}, t_{pZL}	6.0 V @ $V_{CC} = 3.3 \pm 0.3 \text{ V}$ $V_{CC} \times 2$ @ $V_{CC} = 2.5 \pm 0.2 \text{ V}$ @ $V_{CC} = 1.8 \text{ V}$
t_{pHZ}, t_{pZH}	GND

AC WAVEFORM

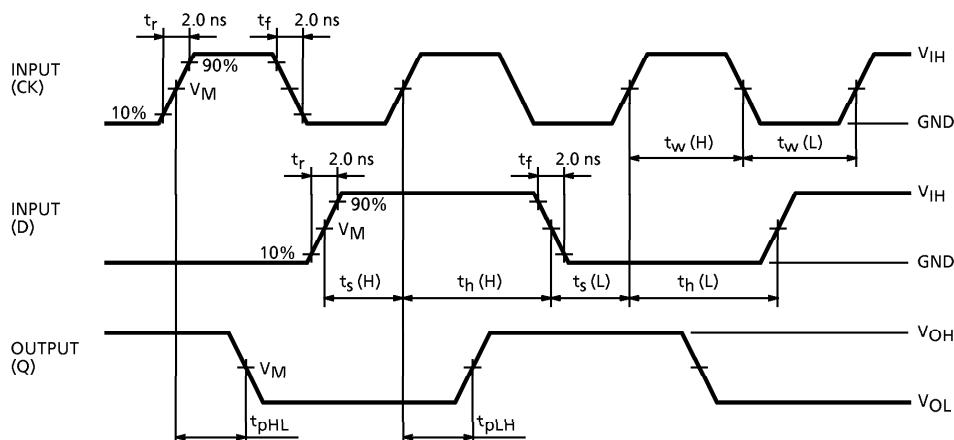
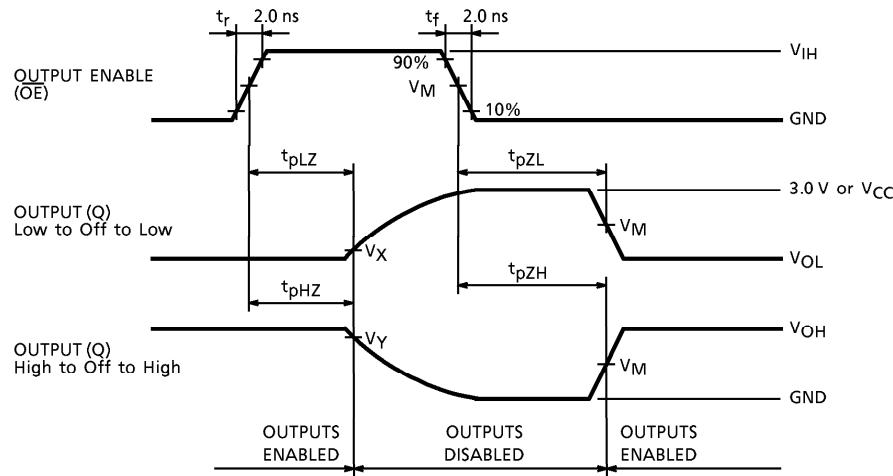
Fig.2 $t_{pLH}, t_{pHL}, t_w, t_s, t_h$ 

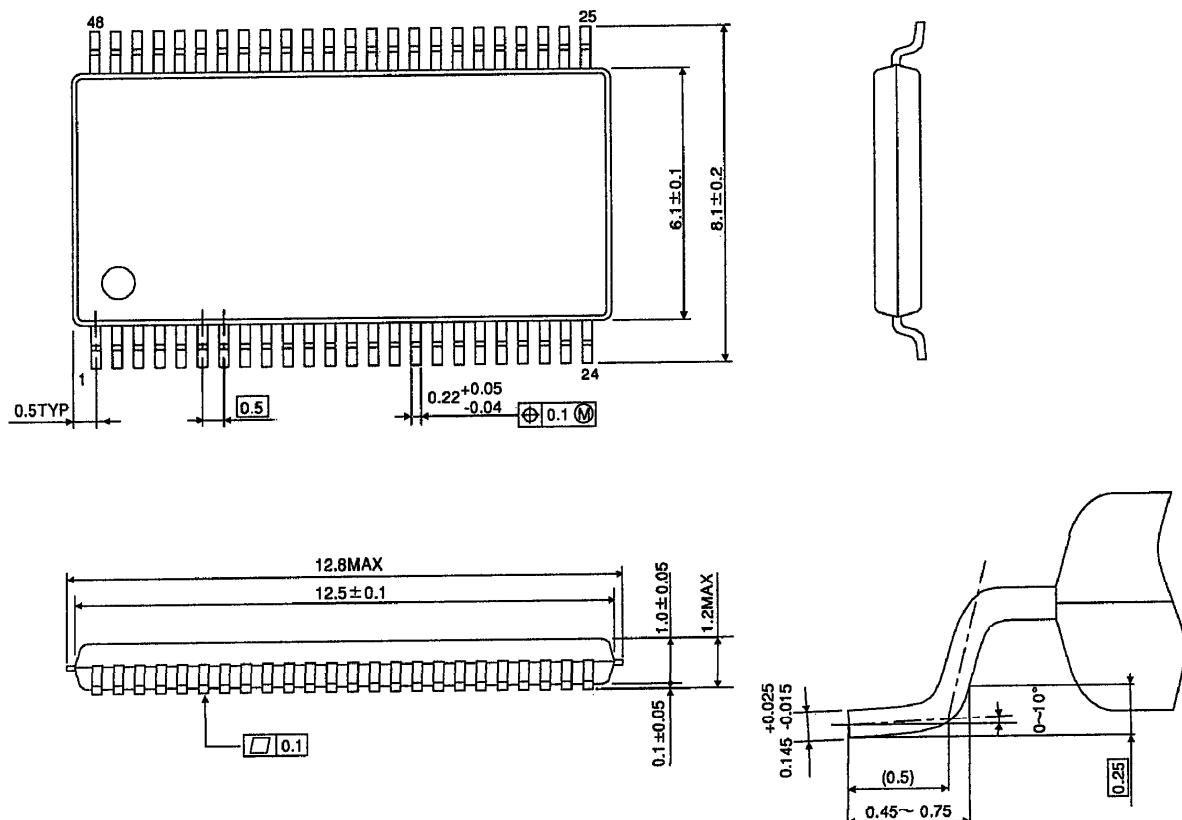
Fig.3 t_{PLZ} , t_{PHZ} , t_{PZL} , t_{PZH} 

SYMBOL	V_{CC}		
	$3.3 \pm 0.3\text{ V}$	$2.5 \pm 0.2\text{ V}$	1.8 V
V_{IH}	2.7 V	V_{CC}	V_{CC}
V_M	1.5 V	$V_{CC} / 2$	$V_{CC} / 2$
V_X	$V_{OL} + 0.3\text{ V}$	$V_{OL} + 0.15\text{ V}$	$V_{OL} + 0.15\text{ V}$
V_Y	$V_{OH} - 0.3\text{ V}$	$V_{OH} - 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$

PACKAGE DIMENSIONS

TSSOP48-P-0061-0.50

Unit : mm



Weight : 0.25 g (Typ.)